

02-20-04



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT : Shacham-Diamand et al.
Serial No. : 10/750,716
Filed : January 2, 2004
For : Copper Molybdenum Electroless
Deposition Process and Materials
Examiner : N/A
Art Unit : N/A

ATTY DOCKET: 206,407

February 18, 2004

PRELIMINARY AMENDMENT

Preliminary to the examination of this application, please amend the claims as indicated on the following sheets.

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